



Product Change Notification

Change Notification #: PCN 115726 - 00
Change Title: Intel® Server Power supply AXX1100PCRPS,
PCN 115726-00, Product Material,
Package Improvement

Date of Publication: August 10, 2017

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *:	September 01, 2017
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes to the Intel® Server Power supply AXX1100PCRPS:

1. Replace the VCI paper (Vapor and Contact Corrosion Inhibitor) that is placed into the bag with desiccant.

Desiccant

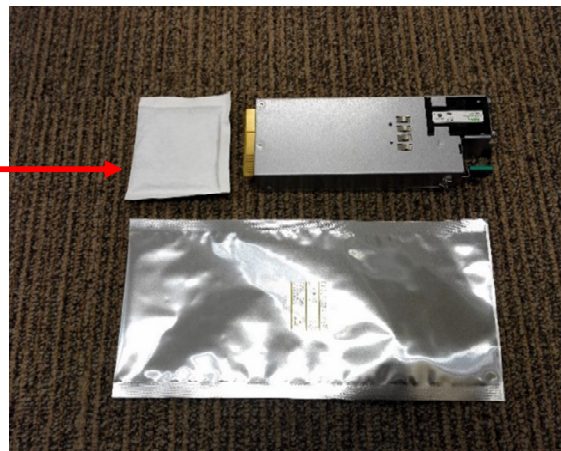


Image Power Supply, Bag and Desiccant

2. New packaging method (images shown below)



Previous Packaging Method



New Packaging Method

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre TA#	Post TA#
AXX1100PCRPS	936183	H44589-001	H44589-002

PCN Revision History:

Date of Revision:
August 10, 2017

Revision Number:
00

Reason:
Originally Published PCN



Product Change Notification

115726 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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